



Parameter	Rating	Units
Peak Blocking Voltage	400	V _P
Load Current	140	mA
Max On-resistance	22	Ω

Features

- 5000V_{rms} Input/Output Isolation
- 400V_P Blocking Voltage
- 100% Solid State
- Small 4-Pin Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable

Applications

- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The CPC1390G is a single-pole normally-open (1-Form-A) Solid State Relay with an enhanced input to output isolation barrier of 5000V_{rms}. Clare's patented OptoMOS architecture makes available the optically coupled technology necessary to activate the output's efficient MOSFET switches. Control of the isolated output is accomplished by means of the highly effective GaAlAs infrared LED at the input.

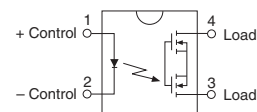
Approvals

- UL Certified Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component: TUV Certificate B 10 05 49410 006

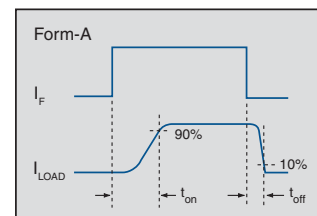
Ordering Information

Part Number	Description
CPC1390G	4-Pin DIP (100/Tube)
CPC1390GV	4-Pin DIP V-Bend (100/Tube)
CPC1390GR	4-Pin Surface Mount (100/Tube)
CPC1390GRTR	4-Pin Surface Mount (1000/Reel)

Pin Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Peak Blocking Voltage	400	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation ¹	100	mW
Total Package Dissipation ²	550	mW
Isolation Voltage, Input to Output	5000	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

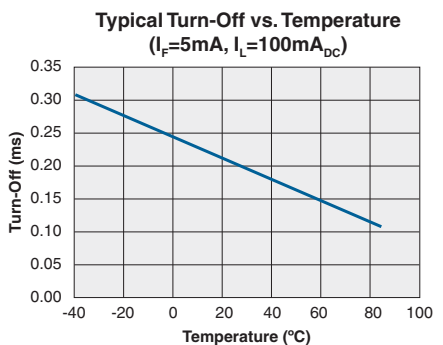
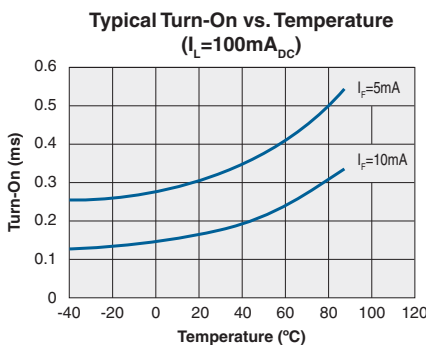
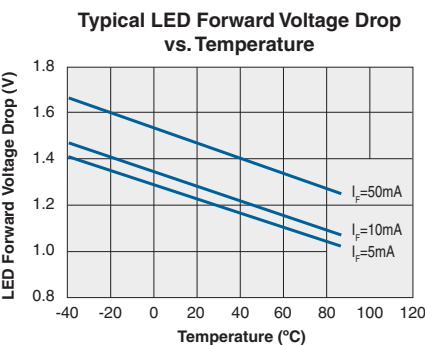
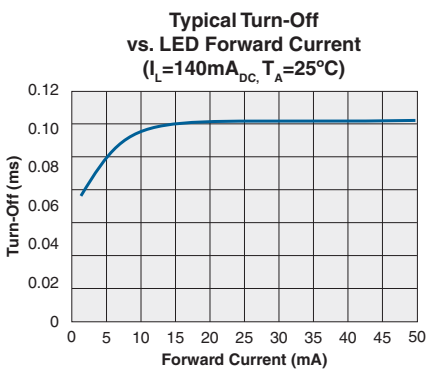
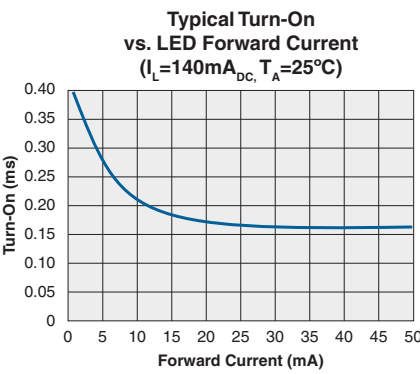
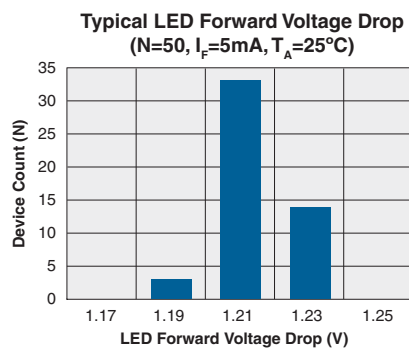
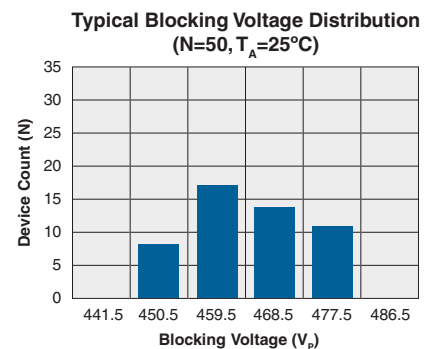
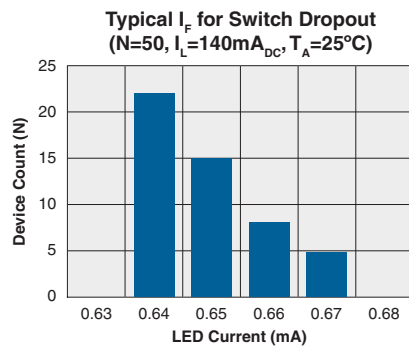
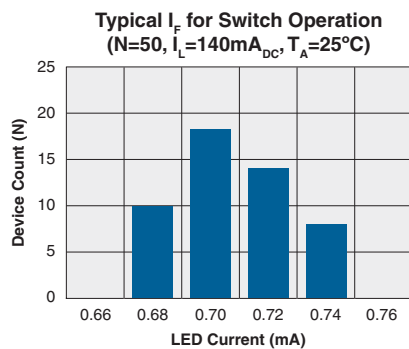
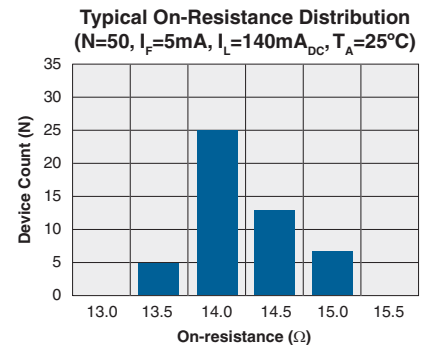
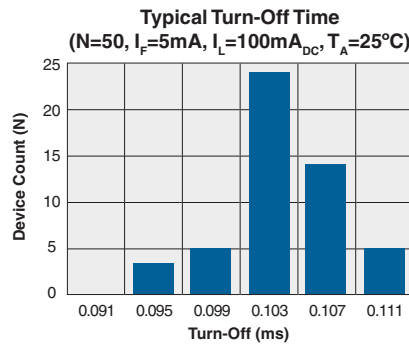
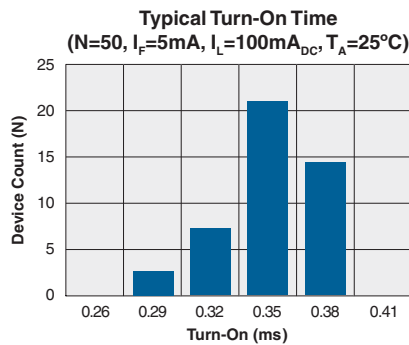
² Derate linearly 3.00 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

Parameters	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Continuous	-	I _L	-	-	140	mA
Peak	t=10ms	I _{LPK}	-	-	400	
On-Resistance	I _L =140mA	R _{ON}	-	14	22	Ω
Off-State Leakage Current	V _L =400V _P	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	t _{on}	-	-	1	ms
Turn-Off		t _{off}	-	-	0.5	
Output Capacitance	I _F =0mA, V _L =50V, f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics						
Input Control Current	I _L =140mA	I _F	-	0.7	2	mA
Input Dropout Current	-	I _F	0.2	0.65	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

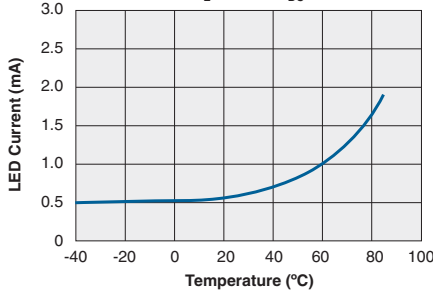
PERFORMANCE DATA*



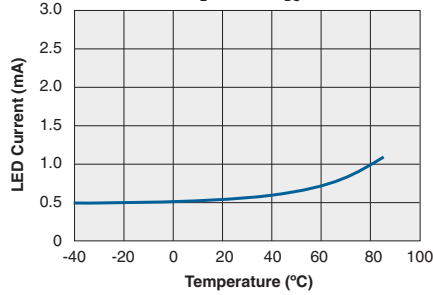
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*

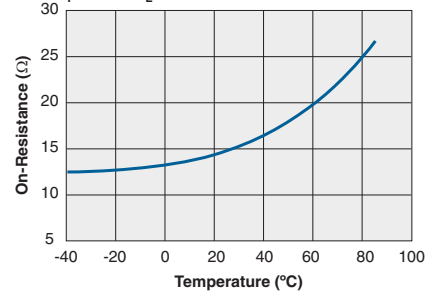
Typical I_F for Switch Operation vs. Temperature
($I_L=100mA_{DC}$)



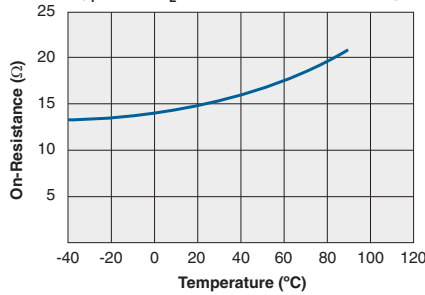
Typical I_F for Switch Dropout vs. Temperature
($I_L=100mA_{DC}$)



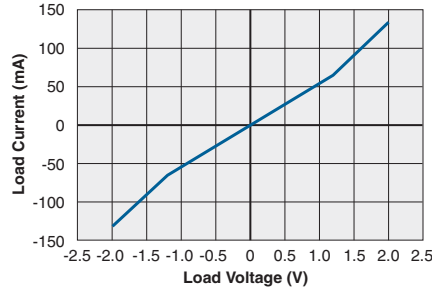
Typical On-Resistance vs. Temperature
($I_F=2mA$, $I_L=Max\ Rated\ @\ Temperature$)



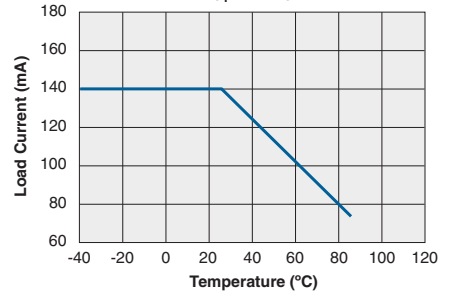
Typical On-Resistance vs. Temperature
($I_F=2mA$, $I_L=100mA\ Instantaneous$)



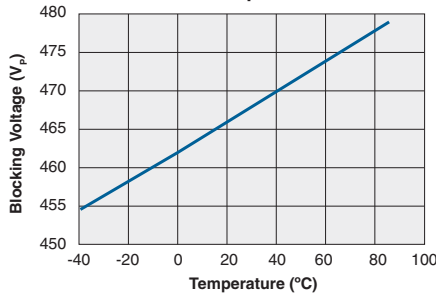
Typical Load Current vs. Load Voltage
($I_F=5mA$, $T_A=25°C$)



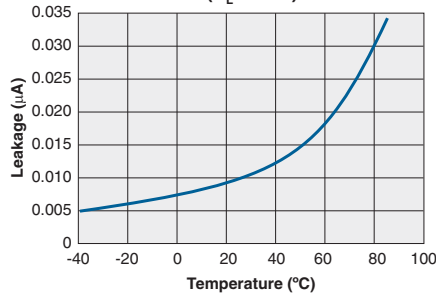
Typical Load Current vs. Temperature
($I_F=2mA$)



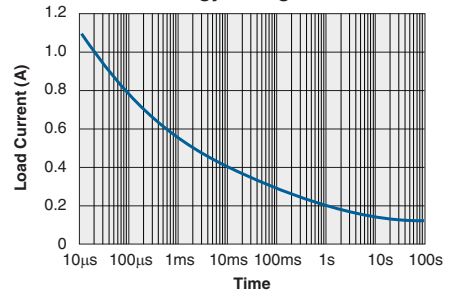
Typical Blocking Voltage vs. Temperature



Typical Leakage vs. Temperature Measured Across Pins 3 & 4
($V_L=400V$)



Energy Rating Curve



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1390G / CPC1390GV / CPC1390GR	MSL 1

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1390G / CPC1390GV / CPC1390GR	250°C for 30 seconds

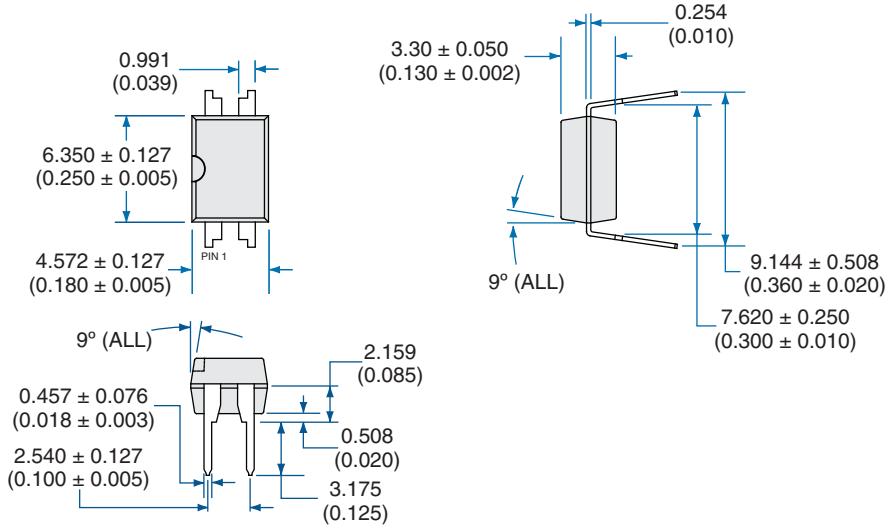
Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

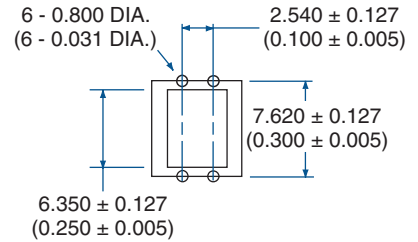


MECHANICAL DIMENSIONS

CPC1390G

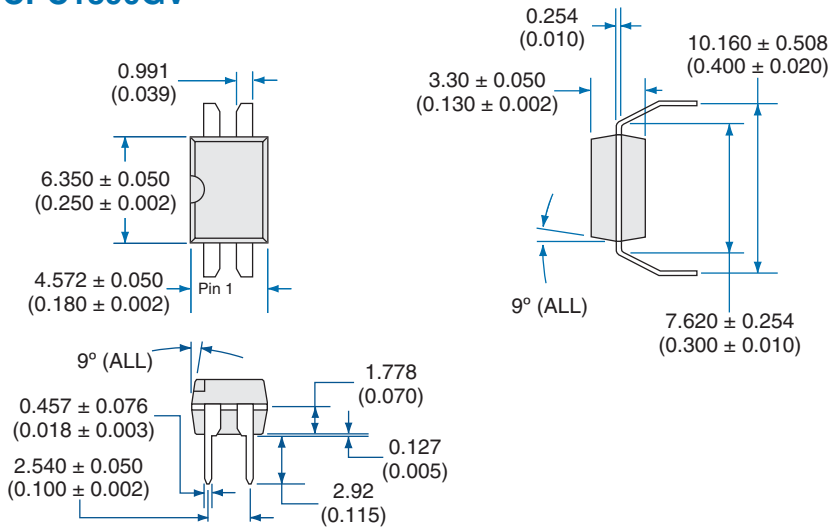


PC Board Pattern (Top View)

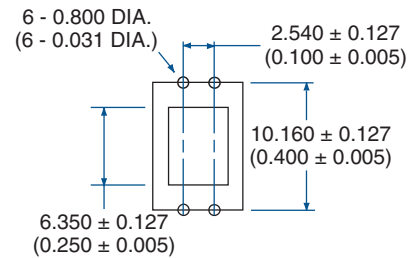


Dimensions
mm
(inches)

CPC1390GV

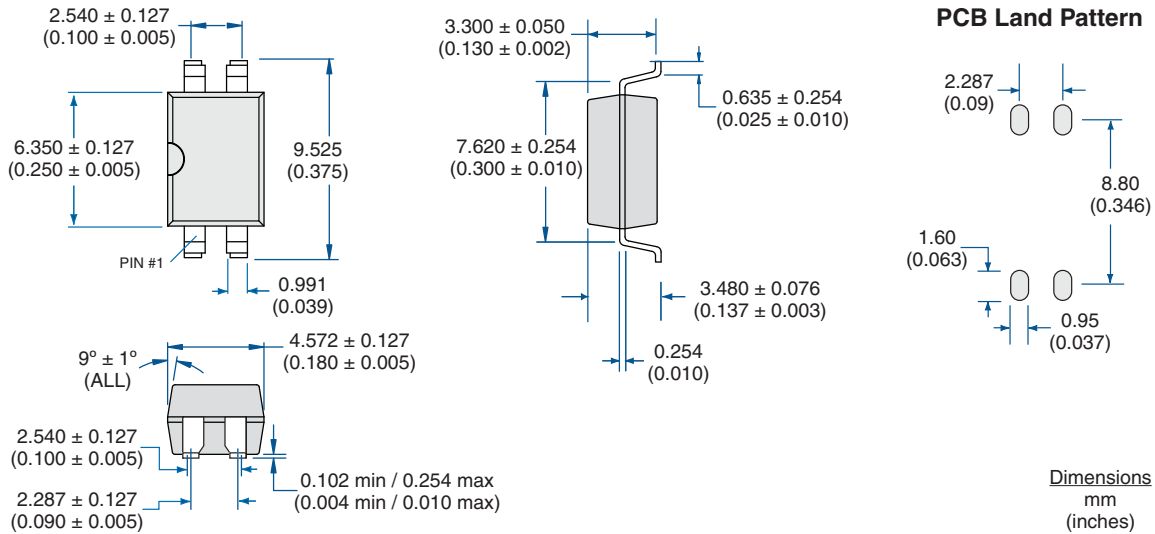


PC Board Pattern (Top View)

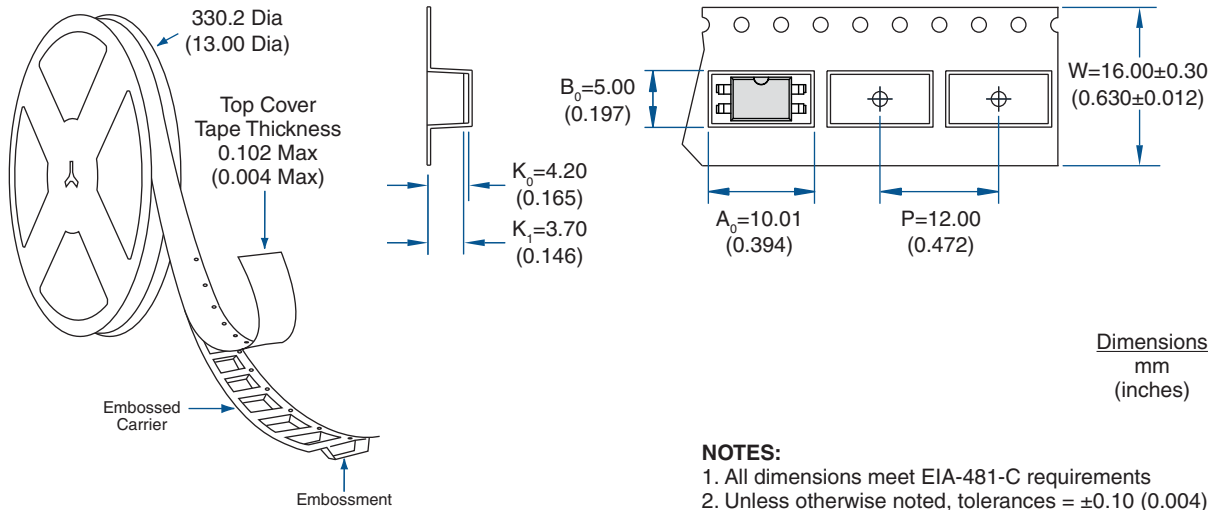


Dimensions
mm
(inches)

CPC1390GR



CPC1390GR Tape & Reel



- NOTES:**
1. All dimensions meet EIA-481-C requirements
 2. Unless otherwise noted, tolerances = ± 0.10 (0.004)

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